



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	DONNIY LIM	<b>Contact Title</b>	Global Account Manager		
<b>Company Unique ID</b>	-	<b>Response Date</b>	2014-07-04	<b>Contact Email</b>	donniy.lim@te.com				
<b>Contact Phone Number</b>	+60-4-8102110								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1734753-1	<b>Amount</b>	715.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>		<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions - true								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products - true								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Material	1	Contact - Au Plating				1.0	0.75	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.15	1.0	0.001125	mg	
Substance	2	Gold	Supplier	7440-57-5	99.85	1.0	0.74887	mg	
Material	1	Contact - Ni Plating				1.0	0.75	mg	
Substance	2	Nickel	Nickel	7440-02-0	100.0	1.0	0.75	mg	
Material	1	Contact - Sn Plating				1.0	0.75	mg	
Substance	2	Tin	Supplier	7440-31-5	100.0	1.0	0.75	mg	
Material	1	Shield - Sn Plating				1.0	1.5	mg	
Substance	2	Tin	Supplier	7440-31-5	100.0	1.0	1.5	mg	
Material	1	Shield - Ni Plating				1.0	1.5	mg	
Substance	2	Nickel	Nickel	7440-02-0	100.0	1.0	1.5	mg	
Material	1	Housing				1.0	100.0	mg	
Substance	2	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	40.0	1.0	40.0	mg	
Substance	2	Phenol, 4,4-(1-methylethylidene)bis[2,6-dibromo-, polymer with 2,2-[(1-methylethylidene)bis(2,6-dibromo-4,1-phenylene)oxy methylene]]bis[oxirane]	Supplier	68928-70-1	20.0	1.0	20.0	mg	
Substance	2	Antimony oxide (Sb2O3)	Supplier	1309-64-4	10.0	1.0	10.0	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	30.0	mg	
Material	1	Contact - Base Material				1.0	8.0	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.2	1.0	0.016	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.2	1.0	0.016	mg	
Substance	2	Tin	Supplier	7440-31-5	6.0	1.0	0.48	mg	
Substance	2	Copper	Supplier	7440-50-8	93.4	1.0	7.472	mg	
Substance	2	Iron	Supplier	7439-89-6	0.15	1.0	0.012	mg	

Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.0040	mg	
Material	1	Shield - Base Material				1.0	601.0	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.2	1.0	1.202	mg	
Substance	2	Copper	Supplier	7440-50-8	93.4	1.0	561.334	mg	
Substance	2	Tin	Supplier	7440-31-5	6.0	1.0	36.06	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.2	1.0	1.202	mg	
Substance	2	Iron	Supplier	7439-89-6	0.15	1.0	0.9015	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.3005	mg	
Material	1	Contact - Pd-Ni Plating				1.0	0.75	mg	
Substance	2	Nickel	Nickel	7440-02-0	20.0	1.0	0.15	mg	
Substance	2	Palladium	Supplier	7440-05-3	80.0	1.0	0.6	mg	